

# SBC-3.5-TGL-UP3

## 11th Gen Intel<sup>®</sup> Core<sup>™</sup> Edge Compute with power-efficient compute and graphics

	HIGHLIGHTS							
		11	CPU Ith Gen Intel® Core™ processors and Intel® Celeron® SoCs			æ	CONNECTIVITY 2x SuperSpeed USB 10Gbps; 2x SuperSpeed USB 20Gbps; 2x USB 2.0; 4x PCle Gen3; 2x 2.5GbE	
	•	l 🗋 In	GRAPHICS Intel® Iris® Xe Architecture with up to 96 EUs, up to 4 independent displays			Ħ	MEMORY Two DDR4 SO-DIMM slots supporting DDR4-3200 ECC memory with IBECC	
		intel partner Gud Windows IoT Enterpri	10 Linux	yç				
MAIN FIELDS OF APP	LICATION							
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		offee & ending	Medical		ıfety & veillance	Indust Automo		
FEATURES								
Intel <sup>®</sup> Core <sup>™</sup> i7-1185G7E, Quad Core @2.8GHz (4.4GHz Turbo) with HT, 12MB Cache, 28W TDP (12W cTDP) Intel <sup>®</sup> Core <sup>™</sup> i5-1145G7E, Quad Core @2.6GHz (4.1GHz			TDP)	Uideo Resolution		DP, eDF	<ul> <li>Up to 5120x3200 @60Hz 24bpp / 7680x4320</li> <li>@60Hz 30bpp with DSC</li> <li>1.4 Up to 4Kx2K 24-30Hz 24bpp</li> </ul>	
	Turbo) with HT, 8MB Cache, 28W Intel® Core™ i3-1115G4E, Dual Co with HT, 6MB Cache, 28W TDP (1 Intel® Celeron® 6305E, Dual Cor	(3.9GHz Turbo)	9	Mass Storage	M.2 SA	TA SSD slot (socket 2 Key B type 2242/3042) ** /Me slot (socket 3 Key M type 2280) PCIe Gen4		
Processor	TDP Intel <sup>®</sup> Core <sup>™</sup> i7-1185GRE, Quad Core @2.8GHz (4.4GHz Turbo) with HT, 12MB Cache, with IBECC, 28W TDP (12W cTDP) – Industrial Intel <sup>®</sup> Core <sup>™</sup> i5-1145GRE, Quad Core @2.6GHz (4.1GHz Turbo) with HT, 8MB Cache, with IBECC, 28W TDP (12W cTDP) - Industrial			572	Networking	connect control M.2 WV on-boo	se-T Ethernet interfaces, supporting 2.5Gb Ethernet tion, managed by as many Intel® i225 2.5GbE lers WAN slot (socket 2 Key B type 2242/3042) coupled to ard Micro-SIM slot. ** Fi/BT slot (socket 1 Key E type 2230)	
	Intel® Core™ i3-1115GRE, Dual Co with HT, 6MB Cache, with IBECC Industrial			€~ <sup>4</sup>	USB	2x Sup	erSpeed USB 10Gbps ports on Dual type-A socket erSpeed USB 20Gbps ports on USB type-C slots 2.0 on pin header	
A Memory	2x DDR4-3200 SODIMM slots Up to 64GB with IBECC supported only with Intel® Core™ Industrial SoCs			ıl.ı	Audio	Mic In,	lio codec / Cirrus Logic CS4207 Line Out and S/PDIF Out, on pin header	
	•••••••••••••••••••••••••••••••••••••••	o decode boxes (VDBoxes) for enhanced			📼 Serial Ports		232/RS-422/RS-485 UARTS software configurable, header	
Graphics	Support for up to 48 simultaneou Support for up to four independent HDR resolution or one display at	ent displays o	displays at up to 4K60		Other	PCle G 8x GPI	ansion M.2 slot (socket 3 Key M type 2280) with 4x en3 lanes Ds, 2x 12C, SPI connectors pageter	
Video Interfaces	2x Multimode DisplayPort 1.4, on Dual DP++ connector /ideo 2x Multimode Display Port 1.4 on USB Type-C connectors (alternate mode)			Interfaces		FAN connector RST_BTN#, PWR_BTN# and activity LED signals on pin header Optional TPM 2.0 on-board		
1x eDP 1.3 or Single/Dual-Channel 18-/24-bit LVDS interfo				Power Supply		+12V <sub>DC</sub> Cablec	+24V <sub>pc</sub> range l coin cell battery for RTC	



## SBC-3.5-TGL-UP3

# 3.5" SBC with the 11th Gen Intel® Core™ and Intel® Celeron® (Codename: Tiger Lake UP3) Processors

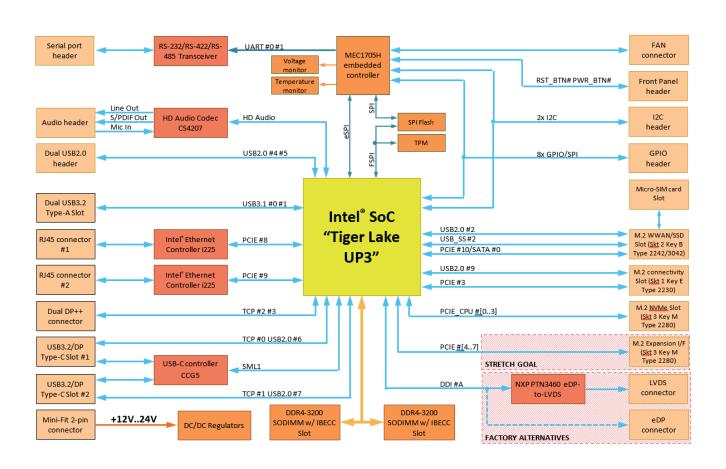
#### FEATURES

os	Operating System	Microsoft® Windows 10 IoT Enterprise LTSC 2021					
	System	Linux (Kernel ≥ 5.4 version)					
	Operating Temperature*	0°C ÷ +60°C (Commercial version) -40°C÷ +85°C (Industrial version)					
L	Dimensions	146 x 102 mm (3.5″ form factor)					

\*Measured at any point of SECO standard heatspreader for this product, during any and all times (including start-up). Actual temperature will depend on the application, enclosure, and/or environment. Each customer must consider application-specific cooling solutions for the final system to keep the heatspreader temperature in the range indicated.

 $^{\star\star}\text{SATA}$  SSD and WWAN functionalities share the same slot and are therefore mutually exclusive.

#### BLOCK DIAGRAM





# Streamline and expedite your edge computing implementations

### **EDGEHOG OS**

A flexible operating system that adapts to your needs, thanks to the customization tool and Docker support. Reliability and security are built-in through a dual-partition system and native integration with Exein's robust AI-based protection.

## **DEVICE MANAGER**

PORTAL

Update, configure, and manage remote devices. Optimize time and costs to maximize operational efficiency and security without the need for costly field interventions.

## DATA ORCHESTRATION

Integrate third-party services, simplify data flows and analysis, and enhance business efficiency by enabling easy and fast utilization of AI. Analyze data from remote devices, customize the user experience with applications tailored to user needs, and manage user rights, company access, and tenant privileges.



